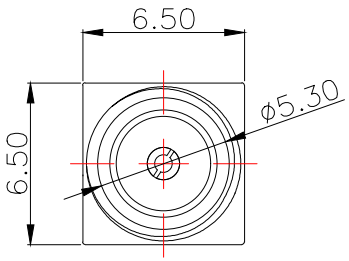
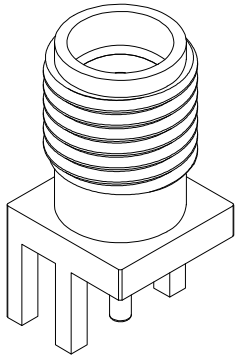
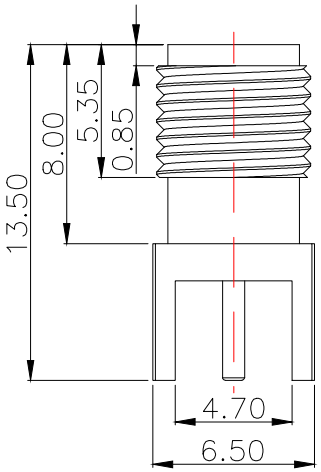
ROHS Compliant

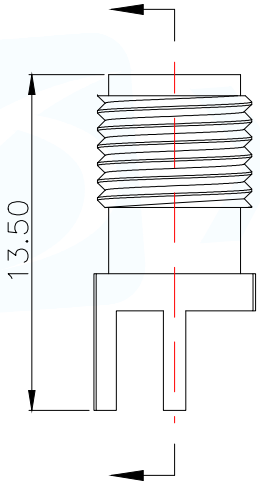
MAPX	MODIFICATION	DATE	DRAW	APPROVE

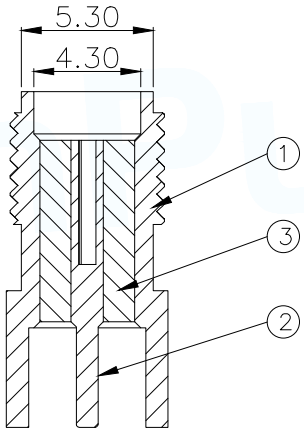


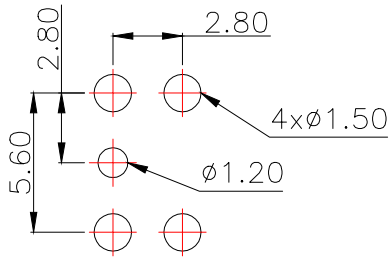


Technical requirements	
Characteristic impedance	50Ω
Frequency range	0-3GHZ
Contact resistance	
Inner conductor	≤3mΩ
Outer conductor	≤2mΩ
Insulated resistance	≥5000MΩ
Salt spray time	48H
Separation force	≥0.28N
Appearance: no shift point burr scratch surface bright, no dirt, no deformation, etc	

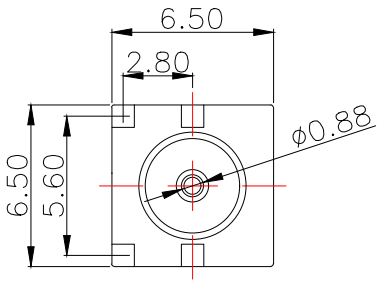








PCB.WELDING DRAWING (TOLERANCE:±0.05)



序号	名称	数量	材料	备注
1	铜座	1	黄铜	镀金
2	平头母针	1	黄铜	镀金
3	绝缘体	1	PTFE	

MANUFACTURE DWG	东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd			
UNLESS OTHERWISE SPECIFED TOLERANCES		TITLE: 镀脚1.6一半螺内孔一H13.5-L8		
		PAR	SMA-KE-347-H13.5-1.6	
		DWN		
DECIMALS: / ANGLES:		CHKD		
X.X±0.30 / X.°±5°		APVD		
X.XX±0.25 / X.X°±1°		SCALE N:A	UNIT:MM	
X.XXX±0.15	CUSTOMER COPY	SIZE:A4	SHEET:1F1	REV:A

Unikeyic Electronics

Global Electronic Components Distributor

Click to view pricing, inventory, delivery, and lifecycle information:

XUNPU:

DSIC-01-LD-GET SMA-KE-347A-H13.5-P WAFER-MX1.25-4PWZ WAFER-XH2.54-5PZZ DP-001-C-J
FPC-0.5AX-8PWBH20 WAFER-100L-3P WAFER-100W-4P TS-1009B-AR05026 PH2.54-07-06PWD
PHB2.0-02-24PWZ WAFER-GH1.25-9PWB WAFER-MX1.25B-10PWZ WAFER-MX1.25B-2PZZ
WAFER-PH2.0-2PJK MCS-302S-C1 WAFER-XH2.54-2PLB FPC-0.5HF-12PWBH20 PCIE-52P40H
SIM-116-ACP7 TF-123-ARP9H17 DSPV-02-LD-GET WAFER-MX3.0-14PWZ WAFER-PH2.0-4PZZ
DSHP-05-TJ-GER FPC-0.5AS-6PWBH20 TS-1009-AR03826 WAFER-MX1.25B-12PZZ
WAFER-PH2.0-8PWZ WAFER-XH2.54-4PLB